



P-Channel 60-V (D-S) MOSFET

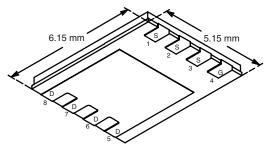
PRODUCT SUMMARY					
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)			
- 60	0.0145 at $V_{GS} = -10 \text{ V}$	- 14.4			
	0.019 at V _{GS} = - 4.5 V	- 12.6			

FEATURES

- Halogen-free According to IEC 61249-2-21 Available
- TrenchFET[®] Power MOSFETs
- Low Thermal Resistance PowerPAK[®] Package with Low 1.07 mm Profile



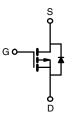
PowerPAK SO-8



Bottom View

Ordering Information: Si7461DP-T1-E3 (Lead (Pb)-free)

Si7461DP-T1-GE3 (Lead (Pb)-free and Halogen-free)



P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	1 A = 25 O, unles				
Parameter		Symbol	10 s	Steady State	Unit
Drain-Source Voltage		V_{DS}	- 60		٧
Gate-Source Voltage		V_{GS}	± 20		
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 25 °C	I_	- 14.4	- 8.6	
	T _A = 70 °C	I _D	- 11.5	- 6.9	
Pulsed Drain Current		I _{DM}	- 60		Α
Continuous Source Current (Diode Conduction) ^a		I _S	- 4.5	- 1.6	^
Avalanche Current	L = 1.0 mH	I _{AS}	50 125		
Single Pulse Avalanche Energy	L = 1.0 IIII1	E _{AS}			
Maximum Power Dissipation ^a	T _A = 25 °C	P _D	5.4	1.9	W
	T _A = 70 °C		3.4	1.2	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150		°C
Soldering Recommendations (Peak Temperature) ^{b,c}		•	260		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^a	t ≤ 10 s	- R _{thJA}	18	23	°C/W	
	Steady State		52	65		
Maximum Junction-to-Case (Drain)	Steady State	$R_{th,IC}$	1.0	1.3	1	

Notes:

- a. Surface Mounted on 1" x 1" FR4 board.
- b. See Solder Profile (<u>www.vishay.com/ppg?73257</u>). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- c. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

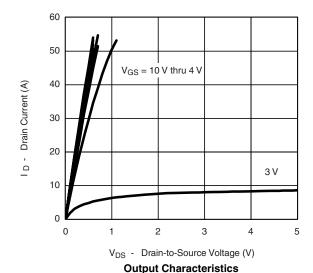
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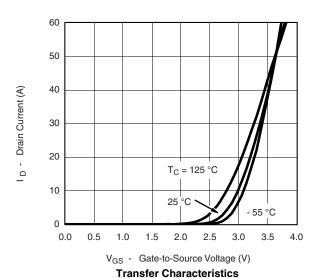


SPECIFICATIONS $T_J = 25 ^{\circ}\text{C}$ Parameter	1	Symbol Test Conditions		Тур.	Max.	Unit	
Static		1000 001101110110	Min.	1 -36-		<u> </u>	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = -250 \mu A$	- 1		- 3	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = - 60 V, V _{GS} = 0 V	,		- 1		
		V _{DS} = - 60 V, V _{GS} = 0 V, T _J = 70 °C			- 10	μΑ	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le -5 \text{ V}, V_{GS} = -10 \text{ V}$	- 40			Α	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 10 V, I _D = - 14.4 A		0.0115	0.0145		
		V _{GS} = - 4.5 V, I _D = - 12.6 A		0.015	0.019	Ω	
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 14.4 A		31		S	
Diode Forward Voltage ^a	V_{SD}	I _S = - 4.5 A, V _{GS} = 0 V		- 0.8	- 1.2	V	
Dynamic ^b							
Total Gate Charge	Qg			121	190	nC	
Gate-Source Charge	Q_{gs}	$V_{DS} = -30 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -14.4 \text{ A}$		20			
Gate-Drain Charge	Q_{gd}			32			
Gate Resistance	R_{g}			3		Ω	
Turn-On Delay Time	t _{d(on)}			20	30		
Rise Time	t _r	V_{DD} = - 30 V, R_L = 30 Ω		20	30	ns	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong$ - 1 A, V_{GEN} = - 10 V, R_g = 6 Ω		205	310		
Fall Time	t _f			90	135		
Source-Drain Reverse Recovery Time	t _{rr}	I _F = - 4.5 A, dl/dt = 100 A/μs		45	70		

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





Notes: a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.

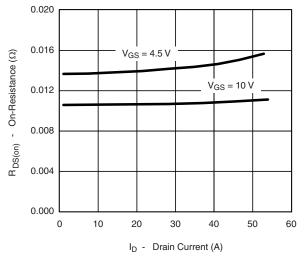
b. Guaranteed by design, not subject to production testing.

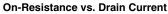


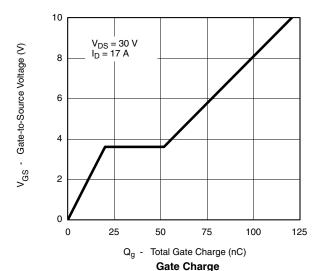


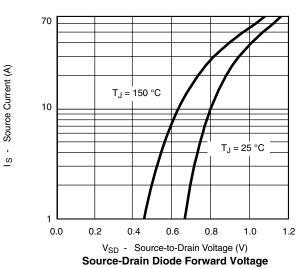


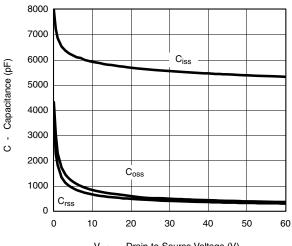
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



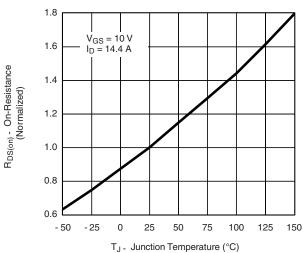




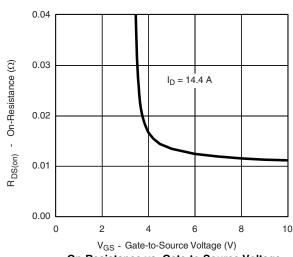




V_{DS} - Drain-to-Source Voltage (V) **Capacitance**



On-Resistance vs. Junction Temperature

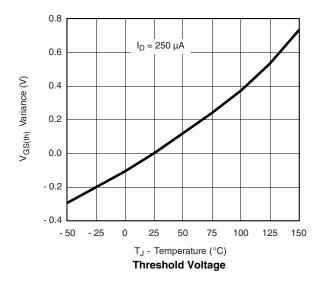


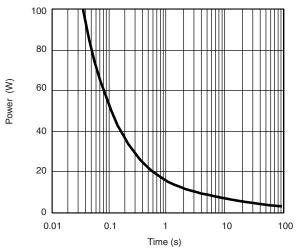
On-Resistance vs. Gate-to-Source Voltage

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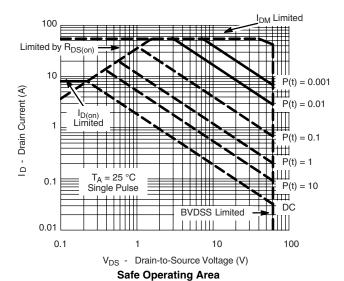
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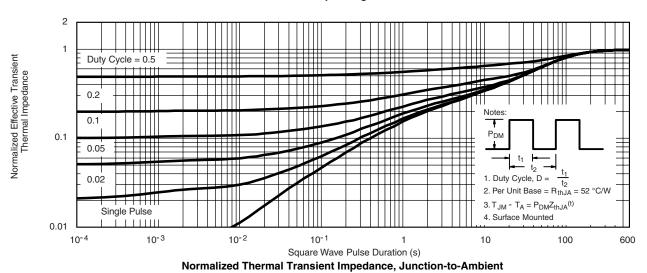
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





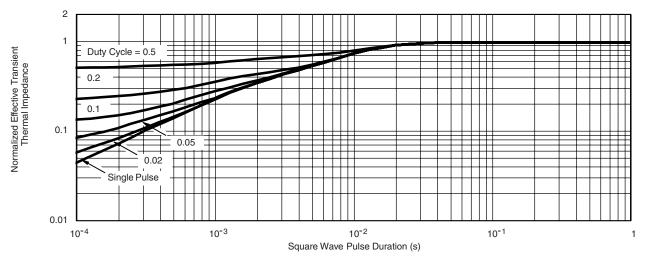
Single Pulse Power, Junction-to-Ambient







TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Case

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